

Features

- Low operating voltage: 3.3V
- Ultra low capacitance: 0.8pF
- Ultra low leakage: nA level
- Low clamping voltage
- -IEC 61000-4-2 (ESD) immunity test
Air discharge: $\pm 25\text{kV}$
Contact discharge: $\pm 25\text{kV}$
- IEC61000-4-4 (EFT) 40A (5/50ns)
- IEC61000-4-5(Lightning):4.5A(8/20 μs)
- These are Pb-Free Devices
- Response Time is Typically < 1 ns

Reference: D3V3F4U6S

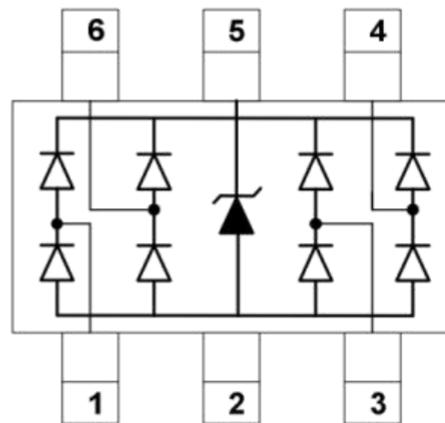
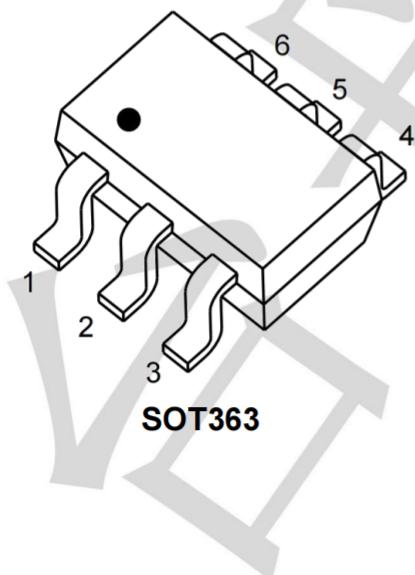
Mechanical Characteristics

- Package: SOT363
- Lead Finish: Matte Tin
- Case Material: "Green" Molding Compound
- Terminal Connections: See Diagram Below
- - IEC 61000-4-2 (ESD) immunity test

Applications

- Cellular Handsets and Accessories
- Notebooks and Handhelds
- Portable Instrumentation
- Industrial Controls

Dimensions and Pin Configuration



Circuit and Pin Schematic

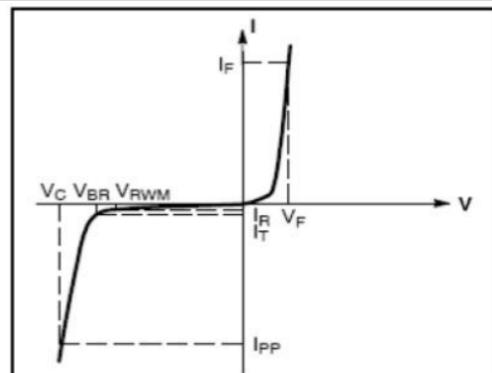
Absolute Maximum Ratings(Tamb=25°C unless otherwise specified)

| Parameter | Symbol | Value | Unit |
|---------------------------------|------------------|-------------|------|
| Peak Pulse Power (8/20μs) | P _{pp} | 60 | W |
| Peak Pulse Current (8/20μs) | I _{pp} | 4.5 | A |
| ESD per IEC 61000-4-2 (Air) | V _{ESD} | ±25 | kV |
| ESD per IEC 61000-4-2 (Contact) | | ±25 | |
| Operating Temperature Range | T _J | -55 to +125 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |

Electrical Characteristics (TA=25°C unless otherwise specified)

| Parameter | Symbol | Min | Typ | Max | Unit | Test Condition |
|-------------------------|-----------------------|-----|------|-----|------|---|
| Reverse Working Voltage | V _{RWM} | -- | -- | 3.3 | V | Any I/O pin to ground |
| Breakdown Voltage | V _{BR} | 3.6 | 4.2 | -- | V | I _T = 1mA, Any I/O pin to ground |
| Reverse Leakage Current | I _R | -- | 1 | -- | uA | V _{RWM} =3.3V, Any I/O pin to ground |
| Forward Voltage | V _F | 0.5 | 0.8 | 1.0 | V | I _F = 10mA |
| Clamping Voltage | V _C | -- | 12.5 | -- | V | I _{pp} =4.5A(8x 20us pulse), Any I/O pin to ground |
| Clamping Voltage | V _C | -- | 12 | -- | V | I _{pp} =8A(8x 20us pulse), V _{CC} pin to ground |
| Junction Capacitance | C _{vo-GND} | -- | 0.45 | 0.8 | pF | V _R =0V, f=1MHz, Any I/O to GND |
| | C _{i/o- i/o} | -- | 0.25 | 0.5 | pF | V _R =0V, f=1MHz, between I/O pins |

| Symbol | Parameter |
|------------------|--|
| V _C | Clamping Voltage @ I _{pp} |
| I _{PP} | Peak Pulse Current |
| V _{BR} | Breakdown Voltage @ I _T |
| I _T | Test Current |
| I _R | Reverse Leakage Current @ V _{RWM} |
| V _{RWM} | Reverse Standoff Voltage |
| V _F | Forward Voltage@ I _F |
| I _F | Forward Current |



V-I characteristics for a uni-directional TVS

Characteristic Curves

Fig1. 8/20 μ s Pulse Waveform

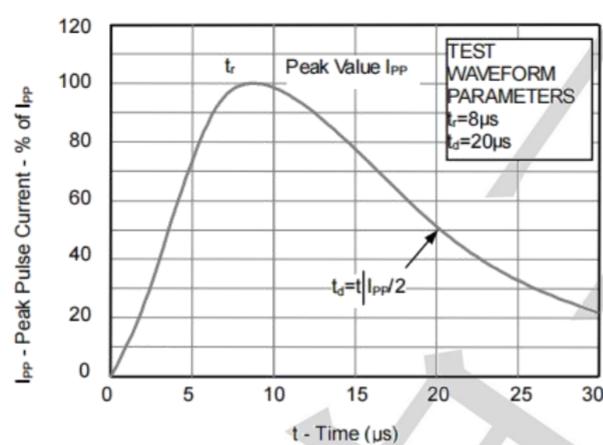


Fig2. ESD Pulse Waveform (according to IEC 61000-4-2)

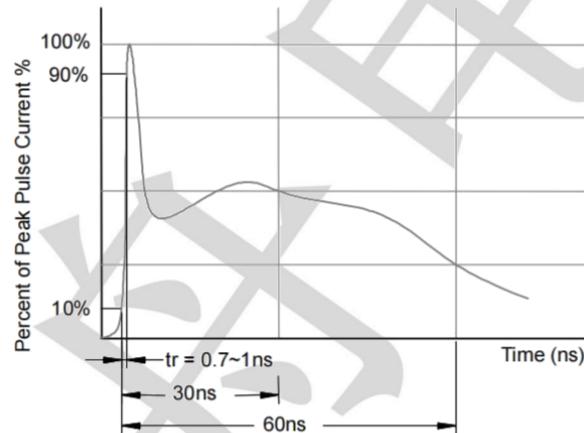
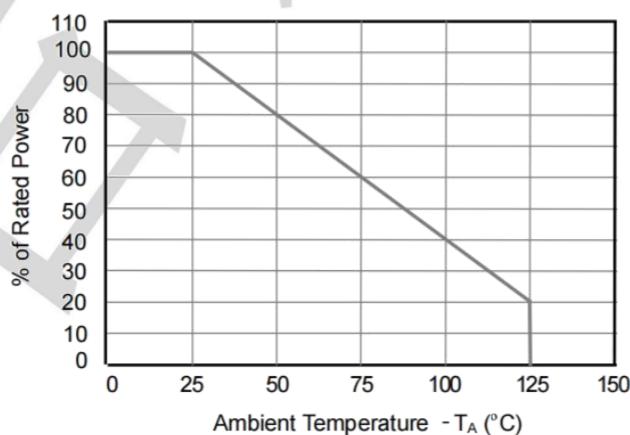
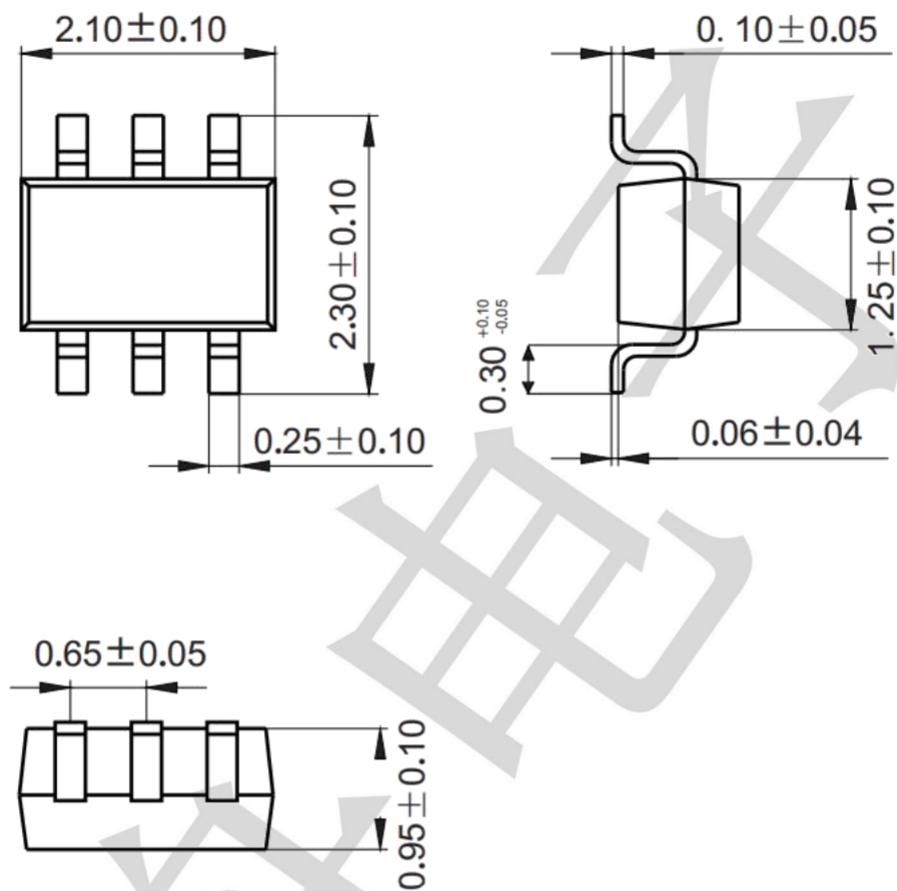


Fig3. Power Derating Curve



Package Outline Dimensions (unit: mm)

SOT363



Mounting Pad Layout (unit: mm)

